

PRODUCT DATASHEET



- ► PLCC2
- ► K1 Series
- ▶ Blue (460-470nm)

N0B09S27 (Tube) N0B09S27RL (Reel)





K1 3W Series





FEATURES:

• Package: PLCC White SMT Package

Forward Current: 700mAForward Voltage (typ.): 3.2V

• Luminous Flux (typ.): 40lm @700mA

Colour: Blue

Wavelength: 460-470nmViewing angle: 155°

• Materials:

Die: InGaN

Resin: Silicon (Water Clear)

• Operating Temperature: -30~+100°C

Storage Temperature: -40~+120°C

Grouping parameters:

- Forward voltage
- Luminous flux
- Wavelength
- Soldering methods: Reflow soldering
- Preconditioning: acc. to JEDEC Level 3
- Packing: 2000pcs/carton (40 tubes); 50pcs/tube
 24mm tape with 1000pcs/reel, ø330mm (13")

APPLICATIONS:

- General Lighting
- Commercial Lighting
- Residential Lighting
- Architectural LightingFlash Lighting
- Reading Lights



CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Forward Current	I _F	700	mA
Peak Forward Current Duty 1/10@10KHz	IFP	800	mA
Operating Temperature	T _{OPR}	-30~+100	°C
Storage Temperature	T _{STG}	-40~+120	°C
Junction Temperature	Tj	110	°C
Temperature Coefficient of VF	$\Delta V_F/\Delta T_j$	-2	mV/°C
Thermal Resistance Junction to Lead	Tjuction-lead	12	°C/W

^{1.} Not suitable to be driven in reverse bias.

Electrical & Optical Characteristics (Ta=25°C)

Parameter	Symbol		Values	Unit	Test		
Parameter	Зуппоп	Min.	Тур.	Max.	Offic	Condition	
Forward Voltage	V_{F}	2.8	3.2	3.6	V	I _F =700mA	
Luminous Flux	Ф۷	30	40		lm	I _F =700mA	
Dominant Wavelength	$\lambda_{\sf d}$	460		470	nm	I _F =700mA	
Viewing Angle	2θ _{1/2}		155		deg	I _F =700mA	

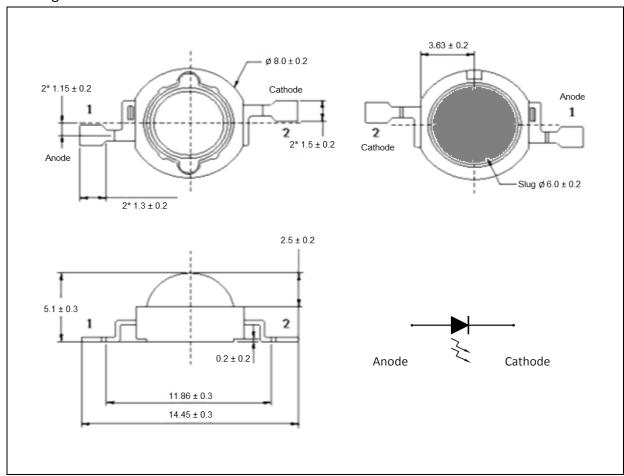
^{2.} Luminous intensity (Iv) $\pm 15\%$, Forward Voltage (V_F) $\pm 0.1V$, Viewing angle($2\theta_{1/2}$) $\pm 5\%$

^{3.} IS standard testing



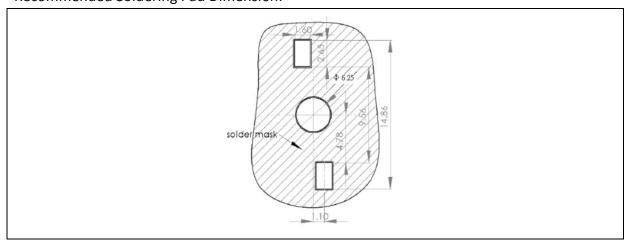
OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm, unless otherwise noted.

Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm with angle tolerance ±0.5°.



BINNING GROUPS:

Forward Voltage Classifications (I_F = 700mA):

Code	Min.	Max.	Unit
1	2.8	2.9	
2	2.9	3.0	
3	3.0	3.1	
4	3.1	3.2	V
5	3.2	3.3	V
6	3.3	3.4	
7	3.4	3.5	
8	3.5	3.6	

Luminous Flux Classifications (I_F = 700mA):

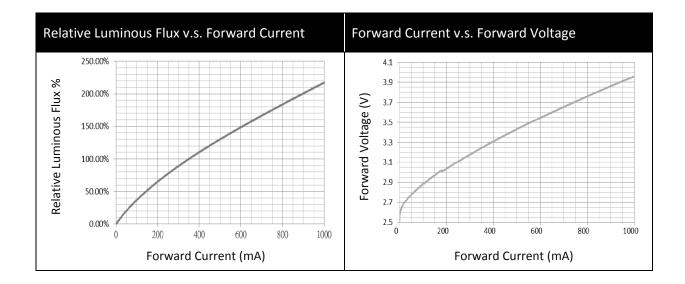
Code	Min.	Max.	Unit
15	30	40	
16	40	50	lm
17	50	60	

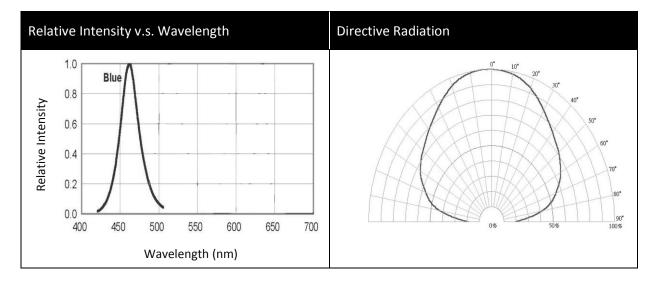
Wavelength Classifications (I_F = 700mA):

Code	Min.	Max.	Unit
B1	460	465	
B2	465	470	nm



ELECTRO-OPTICAL CHARACTERISTICS:

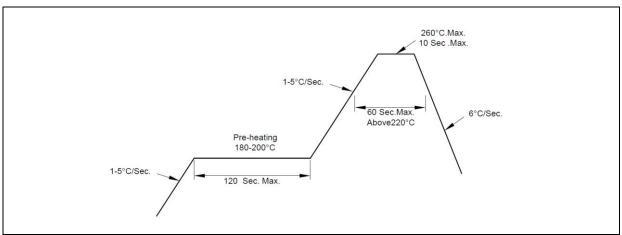






RECOMMENDED SOLDERING PROFILE:

Lead-free Solder:



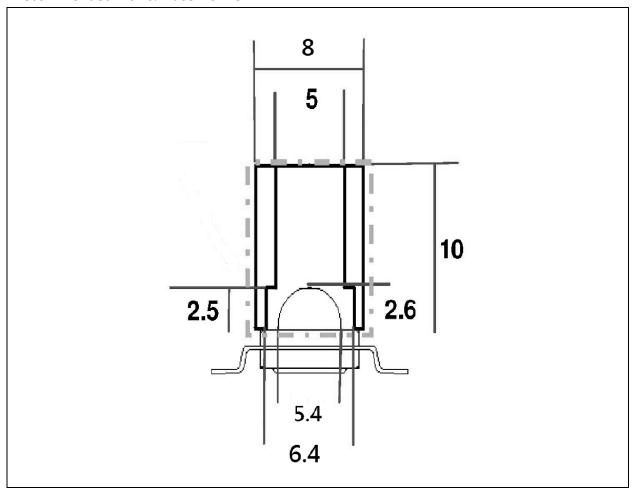
Note:

- 1. Maximum reflow soldering: 1 time.
- 2. Before, during, and after soldering, should not apply stress on the components and PCB board.



RECOMMENDED NOZZLE FOR SMT:

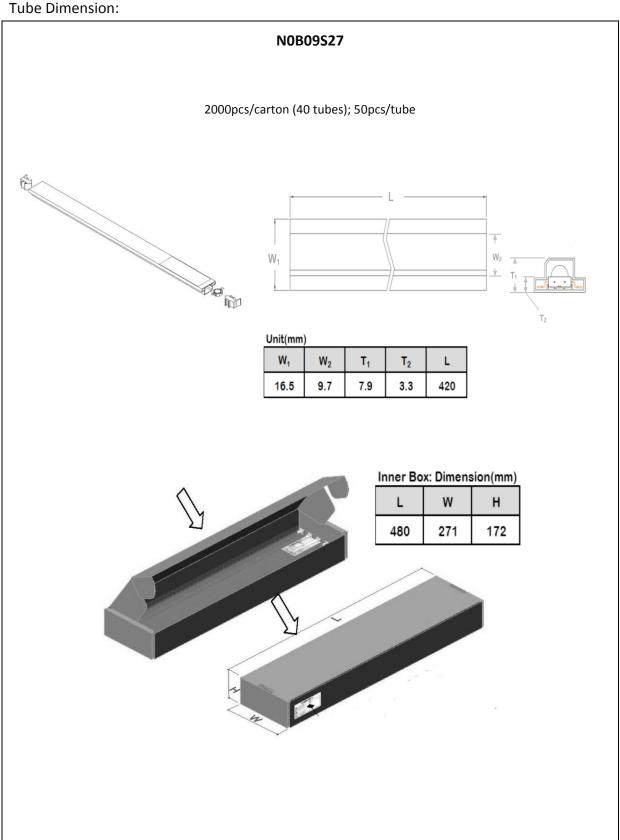
Recommended Pick & Place Nozzle:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm, unless otherwise noted.



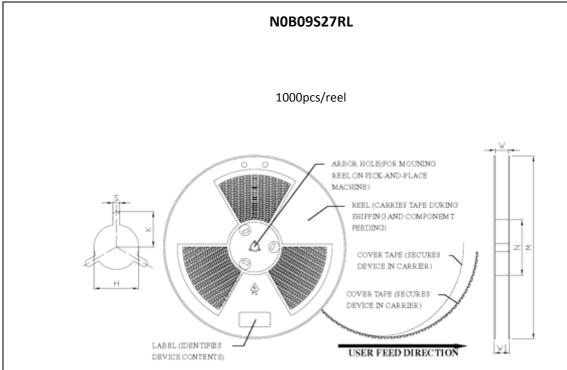
PACKING SPECIFICATION:





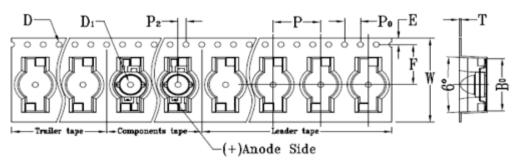
PACKING SPECIFICATION:

Reel Dimension:



Unit: mm

М	N	W	W1	H	K	S
Ф330.0	Ф99.5	24.4	29	Ф13.5	10.75	2.5
±1.0	±1.0	±1.0	±1.0	±0.5	±0.5	±0.5



Unit: mm

W	Р	E	F	P ₂	D	D ₁	P ₀	A ₀	B ₀	K ₀	Т
24.0	12.0	1.75	11.5	2.0	1.5	1.5	4.0	8.2	15.0	6.7	0.4
±0.3	±0.1	±0.1	±0.1	±0.1	±0.1	±0.25	±0.1	±0.1	±0.1	±0.1	±0.05



PRECAUTIONS OF USE:

Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 month at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent and apply baking at 60°C±5°C for 15hrs before use.

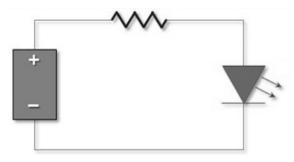
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

- 70±3°C x 24hrs and <5%RH, taped / reel package.
- 100±3°C x 2hrs, bulk (loose) package.
- 130±3°C x 30min, bulk (loose) package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision
A1.0	06/06/2014	Datasheet set-up.